



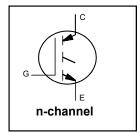
Insulated Gate Bipolar Transistor

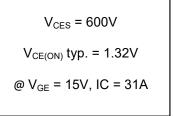
Features

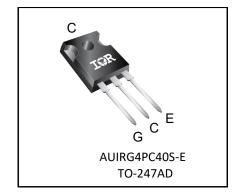
- Standard: Optimized for minimum saturation voltage and low operating frequencies (< 1kHz)
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- Industry standard TO-247AD package
- Lead-Free
- Automotive Qualified*

Benefits

- Generation 4 IGBT's offer highest efficiency available
- IGBT's optimized for specified application conditions
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBT's







G	С	E
Gate	Collector	Emitter

Base part number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
AUIRG4PC40S-E	TO-247AD	Tube	25	AUIRG4PC40S-E

Absolute Maximum Ratings

	Parameter	Max.	Units	
V _{CES}	Collector-to-Emitter Voltage	600	V	
I _C @ T _C = 25°C	Continuous Collector Current	60		
I _C @ T _C = 100°C	Continuous Collector Current	31	۸	
I _{CM}	Pulse Collector Current ①	120	Α	
I _{LM}	Clamped Inductive Load Current ②	120		
$V_{\sf GE}$	Continuous Gate-to-Emitter Voltage	±20	V	
E _{ARV}	Reverse Voltage Avalanche Energy ③	15		
$P_D @ T_C = 25^{\circ}C$	Maximum Power Dissipation	160	۱۸/	
P _D @ T _C = 100°C	Maximum Power Dissipation	65	W	
TJ	Operating Junction and	-55 to +150		
T _{STG}	Storage Temperature Range			
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	С	
	Mounting Torque, 6-32 or M3 Screw	10 lbf·in (1.1 N·m)		

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Thermal Resistance Junction-to-Case		0.77	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink (flat, greased surface)	0.24		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (typical socket mount)		40	
Wt	Weight	6 (0.21)		g (oz)

^{*} Qualification standard can be found at www.infineon.com/



Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage			_		$V_{GE} = 0V, I_{C} = 250\mu A$
$V_{(BR)ECS}$	Emitter-to-Collector Breakdown Voltage @	18	_		V	$V_{GE} = 0V, I_{C} = 1.0A$
$\Delta V_{(BR)CES}/\Delta T_{J}$	Temperature Coeff. of Breakdown Voltage		0.75	_	V/°C	$V_{GE} = 0V$, $I_C = 1mA$
		_	1.32	1.5		$I_{C} = 31A, V_{GE} = 15V, T_{J} = 25^{\circ}C$
$V_{CE(on)}$	Collector-to-Emitter Saturation Voltage	_	1.68	_	V	I_C = 60A, V_{GE} = 15V, See Fig. 2,5
	_	_	1.32	_		$I_C = 31A$, $V_{GE} = 15V$, $T_J = 150$ °C
$V_{GE(th)}$	Gate Threshold Voltage	3.0	_	6.0	V	$V_{CE} = V_{GE}$, $I_C = 250\mu A$
$\Delta V_{GE(th)}/\Delta T_{J}$	Threshold Voltage Temperature Coeff.	_	-9.3		mV/°C	$V_{CE} = V_{GE}$, $I_C = 250\mu A$
gfe	Forward Transconductance®	12	21	_	S	$V_{CE} = 100V, I_{C} = 31A$
		_		250		$V_{GE} = 0V, V_{CE} = 600V$
I _{CES}	Collector-to-Emitter Leakage Current	_		2.0		$V_{GE} = 0V, V_{CE} = 10V, T_{J} = 25^{\circ}C$
				1000		$V_{GE} = 0V, V_{CE} = 600V, T_{J} = 150^{\circ}C$
I _{GES}	Gate-to-Emitter Leakage Current			±100	nA	V_{GE} = ±20V

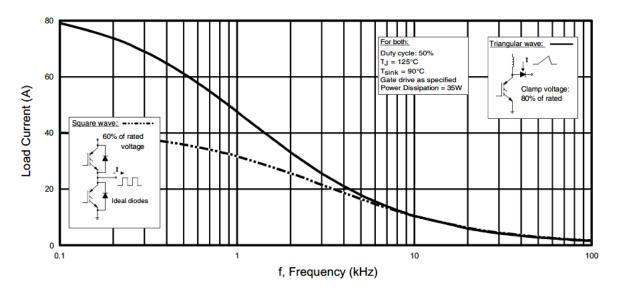
Switching Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max	Units	Conditions	
Q_g	Total Gate Charge (turn-on)	_	100	150		I _C = 31A	
Q_{ge}	Gate-to-Emitter Charge (turn-on)	_	14	21	nC	V _{GE} = 15V See Fig.8	
Q_{gc}	Gate-to-Collector Charge (turn-on)	_	34	51		V _{CC} = 400V	
t _{d(on)}	Turn-On delay time		22	_			
t _r	Rise time	_	18			$I_C = 31A$, $V_{CC} = 480V$, $V_{GE} = 15V$	
$t_{d(off)}$	Turn-Off delay time		650	980	ns	$R_G = 10\Omega, T_J = 25^{\circ}C$	
t _f	Fall time		380	570		F	
Eon	Turn-On Switching Loss	_	0.45	_		Energy losses include "tail"	
E _{off}	Turn-Off Switching Loss	_	6.5		mJ	See Fig. 10, 11, 13, 14	
E _{ts}	Total Switching Loss	_	6.95	9.9		-	
t _{d(on)}	Turn-On delay time		23	_		$I_C = 31A$, $V_{CC} = 480V$, $V_{GE} = 15V$	
t _r	Rise time	_	21	_		$R_G = 10\Omega, T_J = 150^{\circ}C$	
$t_{d(off)}$	Turn-Off delay time	_	1000		ns	Energy lesses include "tail"	
t _f	Fall time	_	940		1	Energy losses include "tail"	
E _{ts}	Total Switching Loss		12	_	mJ	See Fig. 13, 14	
L _E	Internal Emitter Inductance	T —	13	_	nΗ	Measured 5mm from package	
C _{ies}	Input Capacitance	_	2200	_		V _{GE} = 0V	
Coes	Output Capacitance		140	_	pF	V _{CC} = 30V See Fig. 7	
C _{res}	Reverse Transfer Capacitance	_	26	_		f = 1.0Mhz	

Notes

- \odot Repetitive rating; V_{GE} = 20V, pulse width limited by max. junction temperature. (See fig. 13b)
- $@~V_{CC}$ = 80%(V_{CES}), V_{GE} = 20V, L = 10 $\mu H,~R_G$ = 10 $\Omega,$ (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- S Pulse width 5.0µs, single shot.





 $\label{eq:Fig.1} \textbf{Fig. 1} \mbox{ - Typical Load Current vs. Frequency} \\ \mbox{(For square wave, $I=I_{RMS}$ of fundamental; for triangular wave, $I=I_{PK}$)} \\$

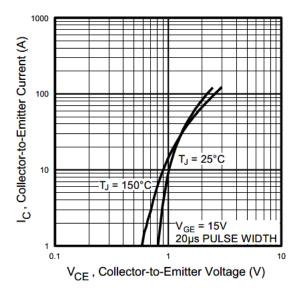


Fig. 2 - Typical Output Characteristics

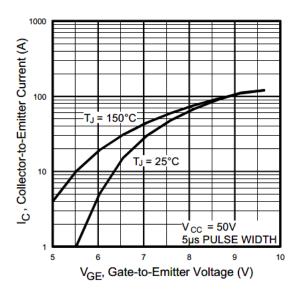


Fig. 3 - Typical Transfer Characteristics

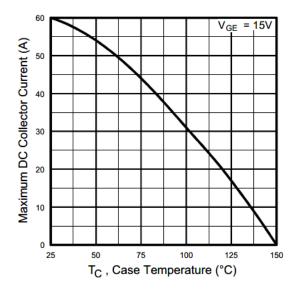


Fig. 4 - Maximum Collector Current vs. Case Temperature

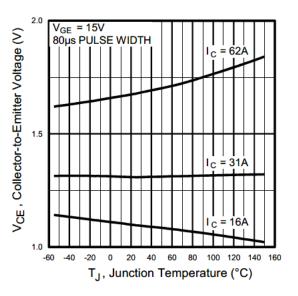


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

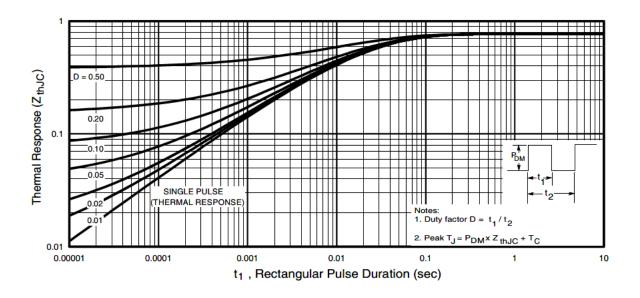


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

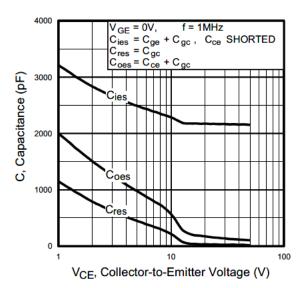


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

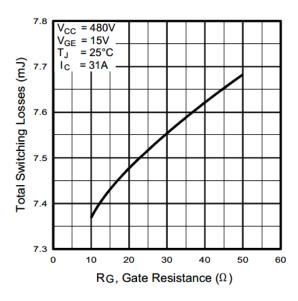


Fig. 9 - Typical Switching Losses vs. Gate Resistance

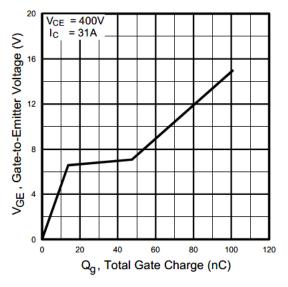


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

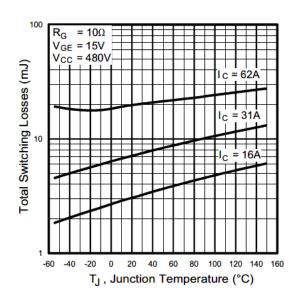


Fig. 10 - Typical Switching Losses vs. Junction Temperature

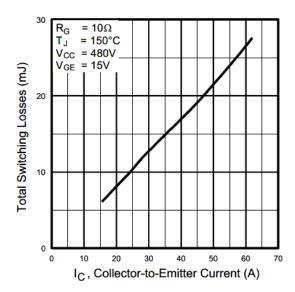


Fig. 11 - Typical Switching Losses vs. Collector-to-Emitter Current

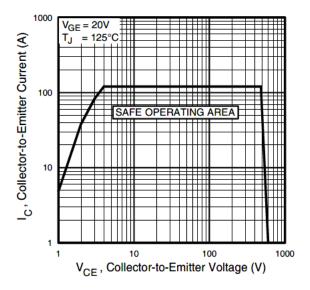
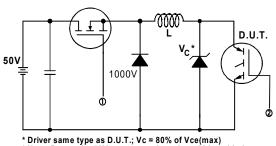


Fig. 12 - Turn-Off SOA





- * Driver same type as D.U.T.; Vc = 80% of Vce(max)

 * Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated ld.
 - Fig. 13a Clamped Inductive Load Test Circuit

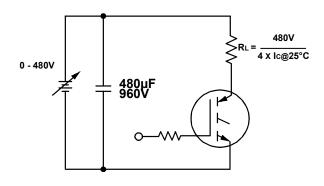
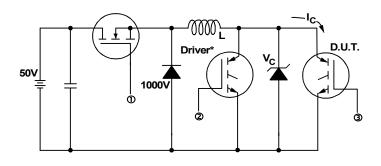


Fig. 13b - Pulsed Collector Current Test Circuit



* Driver same type as D.U.T., VC = 480V

Fig. 14a - Switching Loss Test Circuit

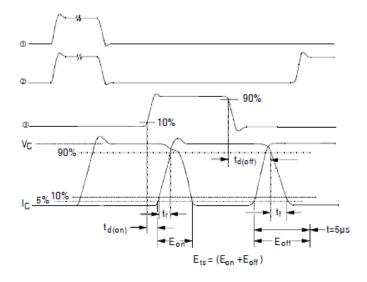
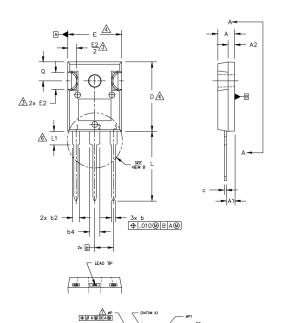
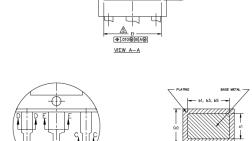


Fig. 14b - Switching Loss Waveforms



TO-247AD Package Outline Dimensions are shown in millimeters (inches)





NOTES:

DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.

DIMENSIONS ARE SHOWN IN INCHES.

CONTOUR OF SLOT OPTIONAL.

DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.

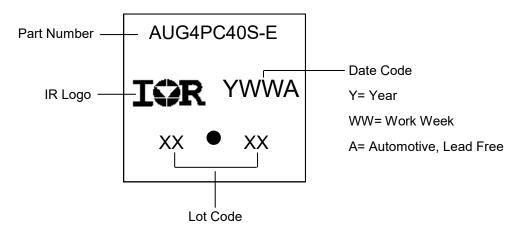
LEAD FINISH UNCONTROLLED IN L1.

ØP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5 'TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.

OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AD.

	DIMENSIONS					
SYMBOL	INC	HES	MILLIM	MILLIMETERS		
	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	.190	.203	4.83	5.13		
A1	.087	.102	2.21	2.59		
A2	.072	.084	1.83	2.13		LEAD ASSIGNMENTS
b	.041	.051	1.04	1.30		ELTIS TIOSISTIMENTO
b1	.041	.050	1.04	1.28		<u>HEXFET</u>
b2	.065	.094	1.65	2.39		1 GATE
b3	.065	.092	1.65	2.34		2 DRAIN
b4	.102	.135	2.59	3.43		3 SOURCE 4 DRAIN
b5	.102	.133	2.59	3.38		
С	.017	.035	0.44	0.88		IGBTs, CoPACK
c1	.017	.034	0.44	0.84		1.— GATE
D	.776	.795	19.71	20.20	4	2 COLLECTOR
D1	.515	_	13.08	_	5	3 EMITTER
D2	.020	.053	0.51	1.35		4 COLLECTOR
E	.604	.625	15.35	15.87	4	
E1	.530	_	13.46	_		DIODES
E2	.178	.216	4.52	5.49		1 ANODE/OPEN
е	.215	BSC	5.46	BSC		2.— CATHODE 3.— ANODE
øk	.0	10	0.:	25		
L	.791	.823	20.10	20.90		
L1	.146	.169	3.71	4.29		
øΡ	.140	.144	3.56	3.66		
øP1	_	.291	_	7.39		
Q	.209	.224	5.31	5.69]	
S	.217	BSC	5.51	BSC		
			1		I	l .

TO-247AD Part Marking Information



TO-247AD package is not recommended for Surface Mount Application.



Qualification Information[†]

		Automotive					
		(per AEC-Q101) ^{††}					
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.					
Moisture	e Sensitivity Level	TO-247AD	-247AD N/A				
		Class H1C (+/- 2000V)					
	Human Body Model	AEC-Q101-001					
ESD		Class C5 (+/- 2000V)					
	Charged Device Model	AEC-Q101-005					
RoHS Compliant		Yes					

- † Qualification standards can be found at International Rectifier's web site: www.infineon.com
- †† Exceptions to AEC-Q101 requirements are noted in the qualification report.

Revision History

Date	Comments			
08/12/2020	Updated datasheet with corporate template.			
00/12/2020	Update the Dimensions table and package outline drawing on page 8			

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 APT70GR120JD60
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 APT70GR120L
 STGWT60H65FB

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 STGWT40V60DF
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